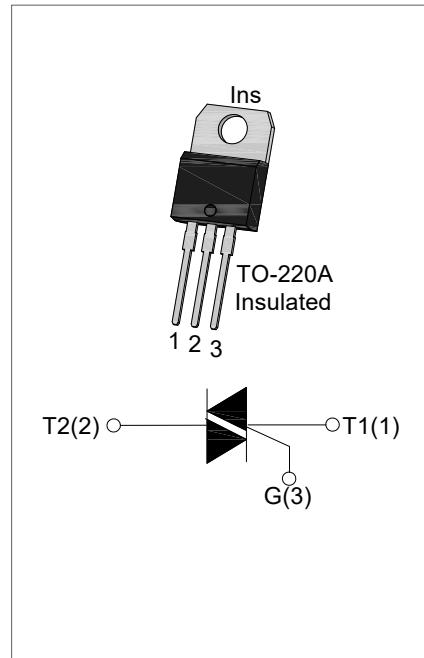


**DESCRIPTION:**

With high ability to withstand the shock loading of large current, JST16A-800BW triac provide high dv/dt rate with strong resistance to electromagnetic interface. With high commutation performances, especially recommended for use on inductive load. From all three terminals to external heatsink, JST16A-800BW provides a rated insulation voltage of 2500 V_{RMS}, complying with UL standards (File ref: E252906). Package TO-220A is RoHS compliant. (2011/65/EU)

**MAIN FEATURES**

Symbol	Value	Unit
I _{T(RMS)}	16	A
V _{DRM} / V _{RMM}	800	V

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Storage junction temperature range	T _{stg}	-40-150	°C
Operating junction temperature range	T _j	-40-125	°C
Repetitive peak off-state voltage (T _j =25°C)	V _{DRM}	800	V
Repetitive peak reverse voltage (T _j =25°C)	V _{RMM}	800	V
Non repetitive surge peak Off-state voltage	V _{DSM}	V _{DRM} +100	V
Non repetitive peak reverse voltage	V _{RSM}	V _{RMM} +100	V
RMS on-state current (T _c =90°C)	I _{T(RMS)}	16	A
Non repetitive surge peak on-state current (full cycle, F=50Hz)	I _{TSM}	160	A
I ² t value for fusing (tp=10ms)	I ² t	128	A ² s
Critical rate of rise of on-state current (I _G =2×I _{GT})	dI/dt	50	A/μs
Peak gate current tp=20uS	I _{GM}	4	A
Average gate power dissipation	P _{G(AV)}	1	W
Peak gate power tp=20uS	P _{GM}	5	W

ELECTRICAL CHARACTERISTICS ($T_j=25^\circ\text{C}$ unless otherwise specified)

Symbol	Test Condition	Quadrant	Value		Unit
I_{GT}	$V_D = 12V$ $R_L = 33\Omega$	I - II - III	MAX	50	mA
V_{GT}		I - II - III	MAX	1.3	V
V_{GD}	$V_D = V_{DRM}$ $T_j = 125^\circ\text{C}$ $R_L = 3.3\text{k}\Omega$	I - II - III	MIN	0.2	V
I_L	$I_G = 1.2I_{GT}$	I - III	MAX	70	mA
		II		80	
I_H	$I_T = 100\text{mA}$		MAX	60	mA
dv/dt	$V_D = 2/3V_{DRM}$ Gate Open $T_j = 125^\circ\text{C}$		MIN	1500	V/ μs

STATIC CHARACTERISTICS

Symbol	Parameter		Value(MAX)	Unit
V_{TM}	$I_{TM} = 22.5\text{A}$	$t_p = 380\mu\text{s}$	$T_j = 25^\circ\text{C}$	1.5
V_{TO}	Threshold voltage		$T_j = 125^\circ\text{C}$	0.93
R_d	Dynamic resistance		$T_j = 125^\circ\text{C}$	$\text{m}\Omega$
I_{DRM}	$V_D = V_{DRM}$	$T_j = 25^\circ\text{C}$	5	μA
I_{RRM}		$T_j = 125^\circ\text{C}$	1	mA

THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	junction to case(AC)	TO-220A(Ins)	1.7	$^\circ\text{C}/\text{W}$

ORDERING INFORMATION

<u>J</u>	<u>ST</u>	<u>16</u>	<u>A</u>	<u>-800</u>	<u>BW</u>	<u>-/</u>
<u>JieJie Microelectronics Co.,Ltd</u>						<u>Blank: Tube</u>
	<u>Triacs</u>					
		<u>I_T(RMS):16A</u>				
			<u>A:TO-220A(Ins)</u>			
					<u>BW:I_GT1-3≤50mA</u>	
					<u>800:V_{DRM}/V_{RRM}≥800V</u>	

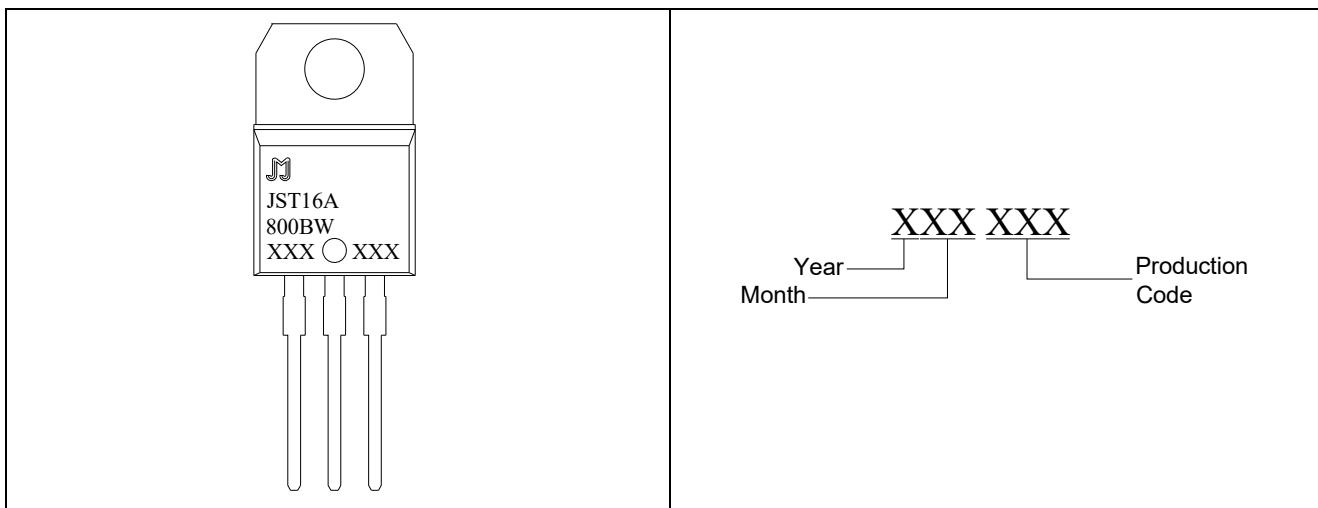
MARKING

FIG.1: Maximum power dissipation versus RMS on-state current

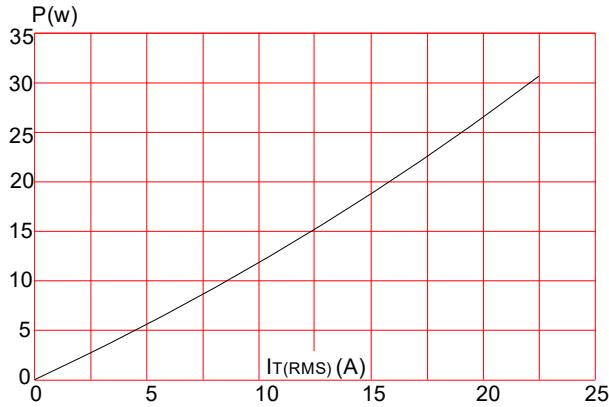


FIG.3: Surge peak on-state current versus number of cycles

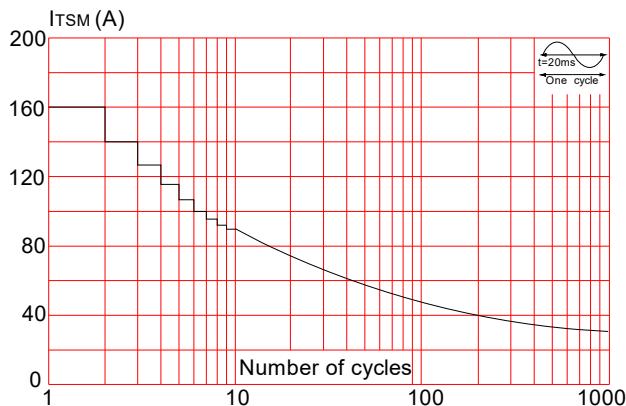


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 20\text{ms}$, and corresponding value of I^2t ($dI/dt < 50\text{A}/\mu\text{s}$)

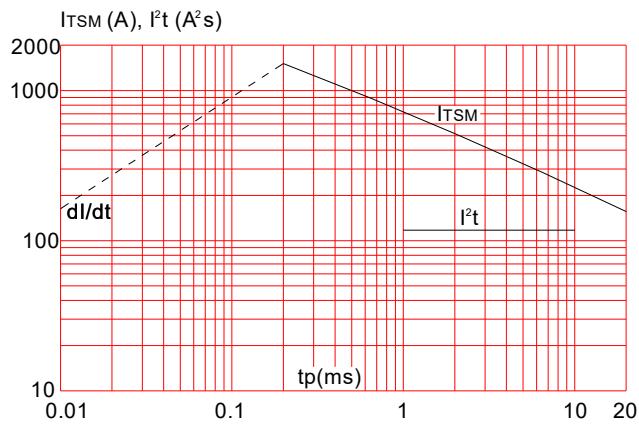


FIG.2: RMS on-state current versus case temperature

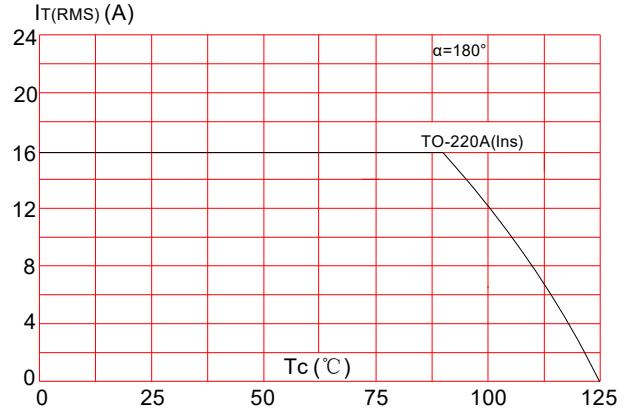


FIG.4: On-state characteristics (maximum values)

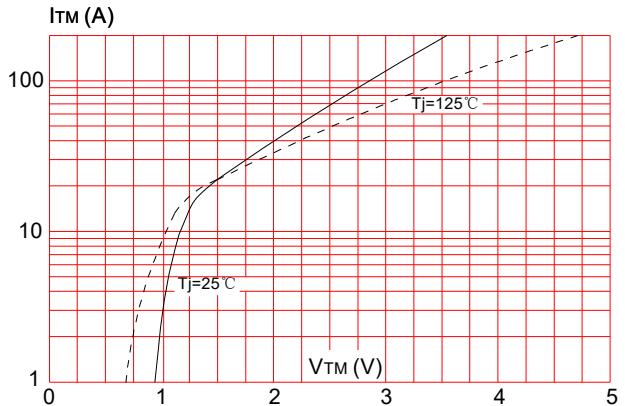
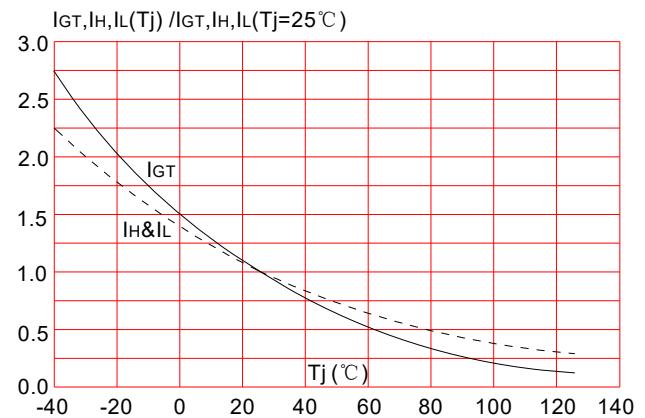


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature



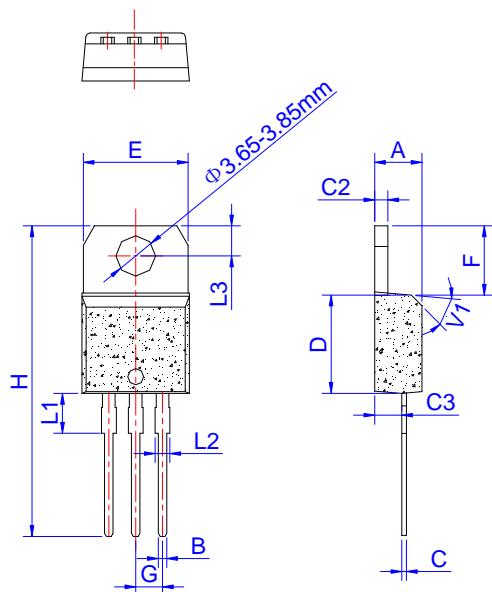
ORDERING INFORMATION

Order code	Voltage V_{DRM}/V_{RRM} (V)	IGT(mA)	Package	Base qty. (pcs)	Delivery mode
JST16A-800BW	800	50	TO-220A(Ins)	50	Tube

Document Revision History

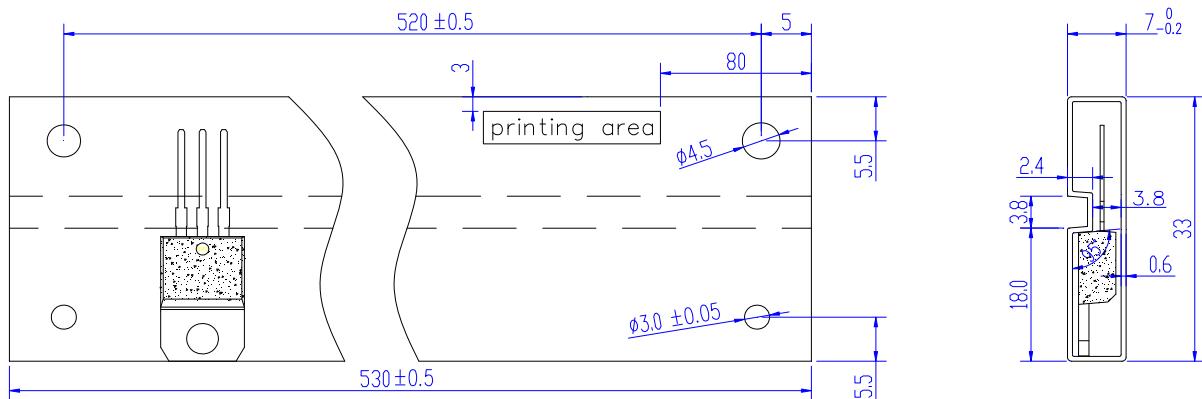
Date	Revision	Changes
Mar 27, 2022	1	Last update

PACKAGE MECHANICAL DATA



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	0.61		0.88	0.024		0.035
C	0.46		0.70	0.018		0.028
C2	1.21		1.32	0.048		0.052
C3	2.40		2.72	0.094		0.107
D	8.60		9.70	0.339		0.382
E	9.80		10.4	0.386		0.409
F	6.55		6.95	0.258		0.274
G	2.40		2.70	0.094		0.106
H	28.0		29.8	1.102		1.173
L1		3.75			0.148	
L2	1.14		1.70	0.045		0.067
L3	2.65		2.95	0.104		0.116
V1		45°			45°	

DELIVERY MODE



PACKAGE	OUTLINE	TUBE (PCS)	INNER BOX (PCS)	PER CARTON
TO-220A	TUBE	50	1,000	5,000



Information furnished in this document is believed to be accurate and reliable. However, Jiangsu JieJie Microelectronics Co.,Ltd assumes no responsibility for the consequences of use without consideration for such information nor use beyond it. Information mentioned in this document is subject to change without notice, apart from that when an agreement is signed, Jiangsu JieJie complies with the agreement. Products and information provided in this document have no infringement of patents. Jiangsu JieJie assumes no responsibility for any infringement of other rights of third parties which may result from the use of such products and information. This document supersedes and replaces all information previously supplied.

is a registered trademark of Jiangsu JieJie Microelectronics Co.,Ltd.

Copyright ©2022 Jiangsu JieJie Microelectronics Co.,Ltd. Printed All rights reserved.